

ThinFlex Corporation

No. 8, Luke 2nd.Rd., Luzhu Dist., Kaohsiung City, 821, Taiwan, R.O.C.
(Kaohsiung Science Park)
Tel: +886-7-6955236 Fax: +886-7-6955539
http://www.thinflex.com.tw
e-mail: service@thinflex.com.tw

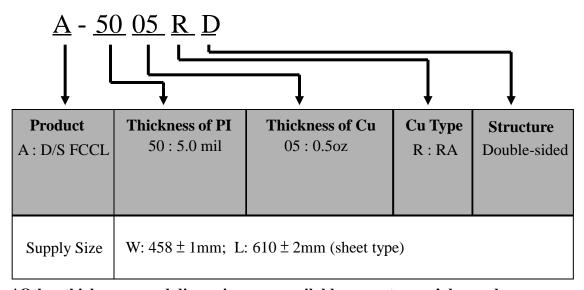
ThinFlex-A, A-5005RD Adhesiveless Double Sided Copper Clad Laminate (Halogen Free)

ThinFlex-A, A-5005RD is an adhesiveless double-sided (D/S) copper clad laminate, using UBE TPI film and laminated with RA copper foil on both sides. ThinFlex-A, A-5005RD adhesiveless D/S composites are designed for a wide variety of flexible circuit applications which require advanced material performance, temperature resistance, fine pitch, and high reliability.

1. Product Characteristics:

- * Excellent dimensional stability
- * Excellent flexibility
- * Finer line etching capability
- * Low moisture absorption
- * Excellent flammability
- * Excellent chemical resistance
- * Excellent thermal, mechanical, and electrical properties

2. Specifications:



^{*}Other thicknesses and dimensions are available on customers' demand.



ThinFlex Corporation

No. 8, Luke 2nd.Rd., Luzhu Dist., Kaohsiung City, 821, Taiwan, R.O.C.
(Kaohsiung Science Park)
Tel: +886-7-6955236 Fax: +886-7-6955539
http://www.thinflex.com.tw
e-mail: service@thinflex.com.tw

3. Construction:

Copper foil

Polyimide film

Copper foil

4. Properties:

Test item	Unit	Specification	Typical Value	Test Method
Peel Strength				
As Received	Kgf/cm	≧ 1.0	2.0	IPC-TM650 2.4.9 B
Solder Float	Kgf/cm	≧ 1.0	2.0	IPC-TM650 2.4.13 B
After Temp. Cycling	Kgf/cm	≧ 1.0	2.0	IPC-TM650 2.4.9
Chemical Resistance	Kgf/cm	≥ 1.0	2.0	IPC-TM650 2.3.2
Tensile Strength (Base Film)	Kg/mm ²	≧30	32	IPC-TM-650 2.4.19
Elongation (Base Film)	%	≧85	106	IPC-TM-650 2.4.19
Tensile Modulus (Base Film)	Kg/mm ²	≥550	580	ASTM D882
Initial Tear Strength (Base Film)	g	≥4200	4400	IPC-TM-650 2.4.16
Propagation Tear Strength (Base Film)	g	≧65	68	IPC-TM-650 2.4.17.1
Flexural Endurance, MIT M.D. T.D.	Cycles Cycles	NA NA	NA NA	JIS-C 6471, 0.8mmR, 0.5kg JIS-C 6471, 0.8mmR, 0.5kg
Electrical Properties Surface Resistance	Ω	~10 ¹¹	~10 ¹²	IPC-TM650 2.5.17
Volume Resistance	Ω-cm	~10 ¹²	~10 ¹⁴	IPC-TM650 2.5.17
Insulation Resistance	Ω	~10 ⁹	~10 ¹⁰	IPC-TM650 2.6.3.2
Dielectric Strength	kV/mil	≥6.9	7.0	ASTM-D149
Dielectric Constant	-	≦3.3	3.2	IPC-TM650 2.5.5.3
Dissipation factor	-	≥ 0.002	0.003	IPC-TM650 2.5.5.3
Physical and Thermal Properties M.D.	%	-0.1~0.1	-0.08~0.08	IPC-TM650 2.2.4C
Dimensional Stability T.D.	%	-0.1~0.1	-0.08~0.08	IPC-TM650 2.2.4C
CTE	ppm/°C	≦19.3	19.0	ThinFlex
T_g	$^{\circ}\!\mathbb{C}$	≥350	355	ThinFlex
Solder Float 10sec at 288°ℂ (550°F)	-	Pass	Pass	IPC-TM650 2.4.13
Moisture Absorption Test	%	≦1.1	1.0	IPC-TM650 2.6.2
Chemical Resistance-single	-	Pass	Pass	IPC-TM650 2.3.2
Thickness tolerance	um	161±10%	160.8	ThinFlex
UL Flame Class	-	≦V-0	V-0	UL94

^{*} Above data are typical values, and are not guaranteed values.

Technical Data Sheet: 201709



ThinFlex Corporation

No. 8, Luke 2nd.Rd., Luzhu Dist., Kaohsiung City, 821, Taiwan, R.O.C. (Kaohsiung Science Park)

Tel: +886-7-6955236 Fax: +886-7-6955539

http://www.thinflex.com.tw
e-mail: service@thinflex.com.tw

5. Storage:

ThinFlex-A, A-5005RD will meet its shelf-life for at least 12 months after arrival at the user's factory when stored in the original packaging at temperatures of below 25°C and below 70% humidity. The products do not need refrigeration and should not be frozen.

Note: The information and data contained in this technical literature is believed to be accurate and is offered in good faith for the benefit of the user. The user should make his own tests to verify the suitability of this product for any application before its use. All data are typical values only and subject to change without notice.

ThinFlex Corporation

No.8, Luke 2nd Rd., Luzhu Dist., Kaohsiung City 821, Taiwan, R.O.C. (Kaohsiung Science Park)

Tel: +886-7-6955236 Fax: +886-7-6955539

http://www.thinflex.com.tw e-mail: service@thinflex.com.tw

Technical Data Sheet: 201709